

60V 16mohm N-channel Enhancement MOSFET
AKT6N160PL

Description:

This N Channel Trench MOSFET has been designed to low on-state resistance , suggested use for battery protection, especially for high efficiency power management applications.

Features:

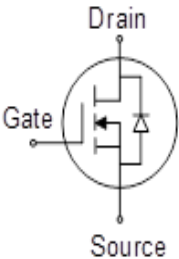
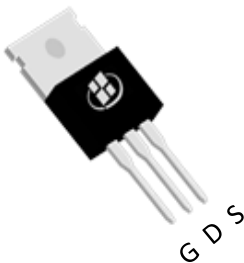
- Advanced Trench Technology
- 100% UIS Tested
- low on-resistance
- RoHS compliant
- Halogen-free

Applications:

- Battery Protection
- Load Switch
- Power Management

Key Performance Parameters:

Parameter	Value	Unit
V_{DS}	60	V
$R_{DS(on), max} @V_{GS} = 10V$	16	mΩ
I_D	58	A



Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKT6N160PL	TO-220	T6N160PL	Tube	See the detail package information

Maximum Ratings (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Value	Units
V _{DS}	Drain-Source Voltage	60	V
I _D	Drain Current - Continuous (T _C = 25°C) ^(Note 1)	58	A
	Drain Current - Continuous (T _C = 100°C)	33	A
I _{DM}	Drain Current - Pulsed ^(Note 2)	232	A
V _{GS}	Gate-Source Voltage	± 20	V
E _{AS}	Single Pulsed Avalanche Energy ^(Note 3)	76	mJ
P _D	Power Dissipation (T _C = 25°C)	104	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C

Thermal Characteristics

Symbol	Parameter	Value	Units
R _{θJC}	Thermal Resistance, Junction-to-Case, Steady-State	1.2	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient, Steady State ^(Note 4)	55	°C/W

Notes:

1. The max drain current rating is silicon limited
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. L = 0.5 mH, V_{DD} = 15 V, I_{AS} = 16 A, R_G = 25 Ω, Starting T_J = 25 °C
4. Mount on minimum PCB layout

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Static Characteristics

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	60			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$			1	μA
I_{GSS}	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$			± 100	nA
$V_{GS(TH)}$	Gate Threshold voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1	1.5	2	V
$R_{DS(ON)}$	Drain-Source on-state resistance	$V_{GS} = 10\text{ V}, I_D = 25\text{ A}$		13	16	$\text{m}\Omega$
		$V_{GS} = 4.5\text{ V}, I_D = 15\text{ A}$		15	20	$\text{m}\Omega$

Dynamic Characteristics

C_{ISS}	Input Capacitance	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V},$ $F = 1\text{ MHz}$		2500		pF
C_{OSS}	Output Capacitance			110		pF
C_{RSS}	Reverse Transfer Capacitance			90		pF
R_G	Gate Resistance	$F = 1\text{ MHz}$		2		Ω

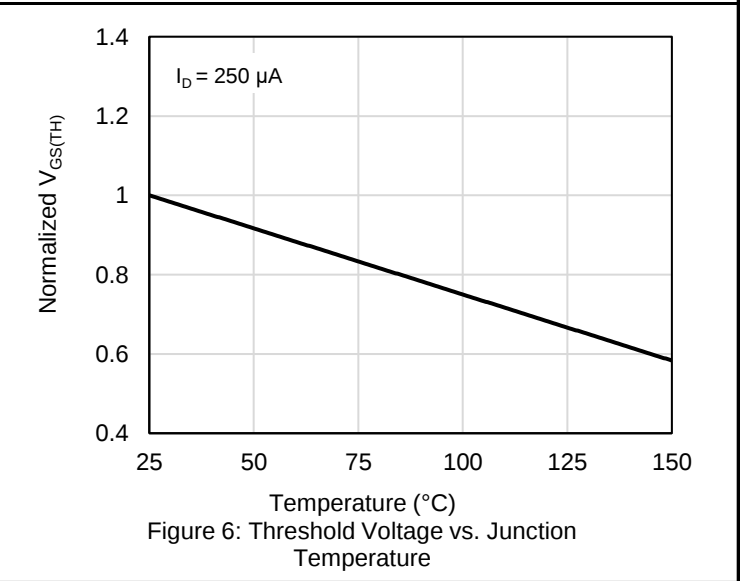
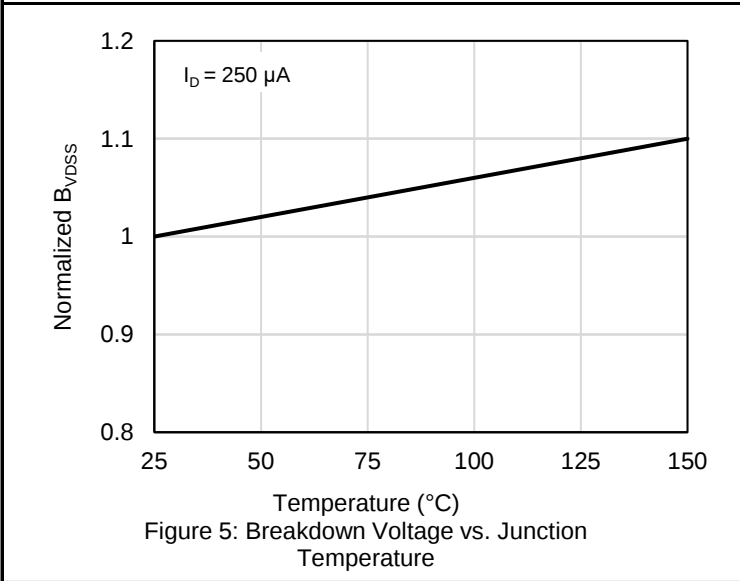
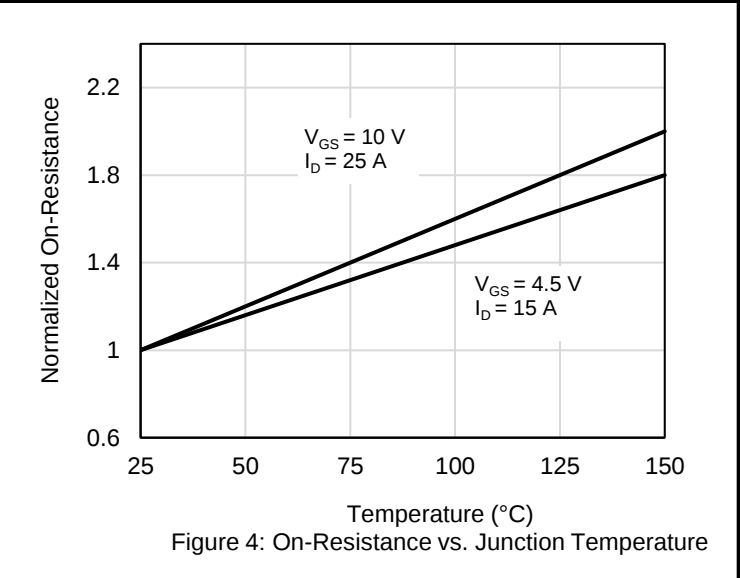
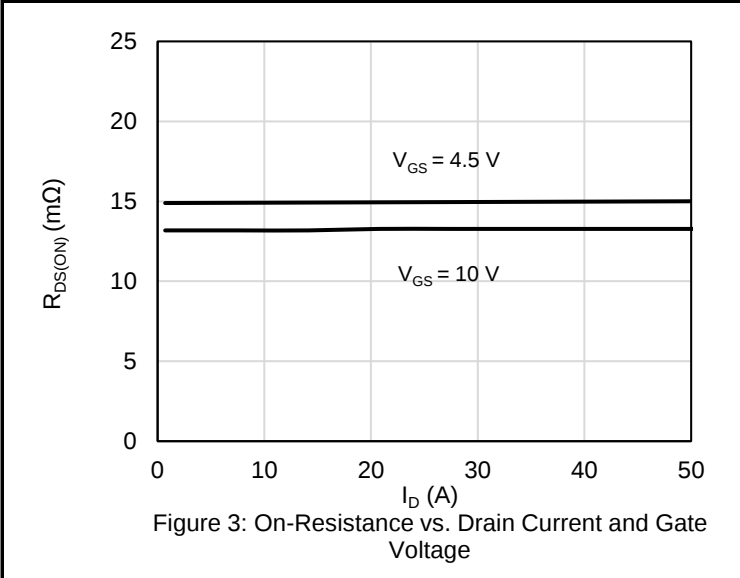
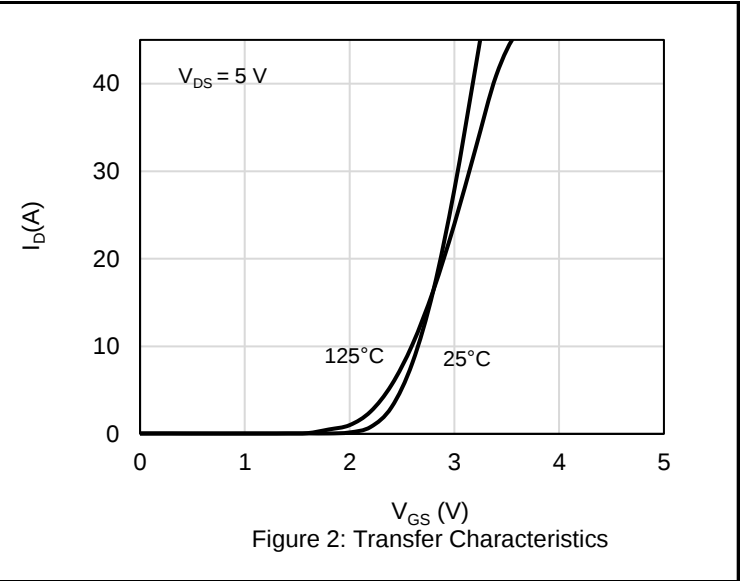
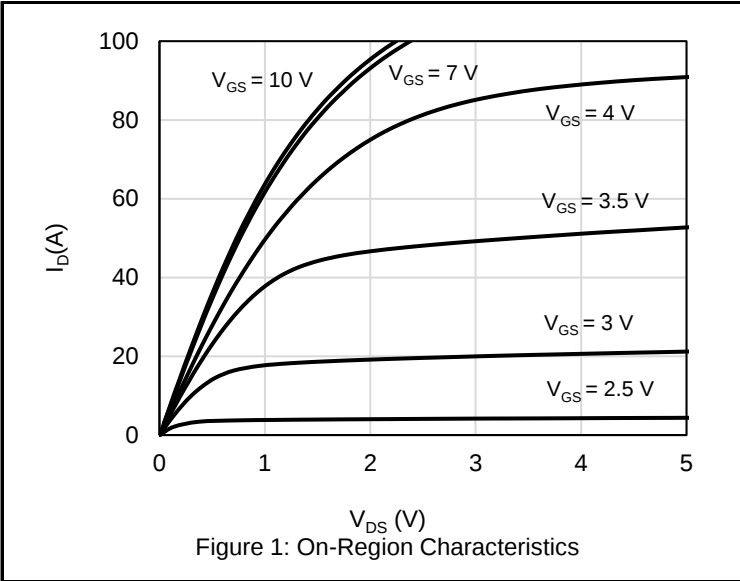
Switching Characteristics

$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 30\text{ V}, R_L = 1\text{ }\Omega,$ $V_{GS} = 10\text{ V}, R_G = 10\text{ }\Omega$		10		ns
T_R	Rise Time			42		ns
$T_{D(OFF)}$	Turn Off Delay Time			85		ns
T_F	Fall Time			60		ns
Q_G	Total Gate Charge	$V_{DD} = 15\text{ V}, I_D = 30\text{ A},$ $V_{GS} = 10\text{ V}$		47		nC
Q_{GS}	Gate-Source Charge			7		nC
Q_{GD}	Gate-Drain Charge			9		nC

Drain-Source Diode Characteristics and Maximum Ratings

I_S	Maximum Continuous Body-Diode Forward Current			58	A
I_{SM}	Maximum Pulsed Body-Diode Forward Current			232	A
V_{SD}	Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 1\text{ A}$		0.72	V
T_{RR}	Reverse recovery time	$V_{DD} = 15\text{ V}, I_D = 30\text{ A},$ $di/dt = 100\text{ A}/\mu\text{s}$		24	ns
Q_{RR}	Reverse recovery charge			26	nC
I_{RRM}	Peak Reverse Recovery Current			2	A

Electrical Characteristics Diagrams



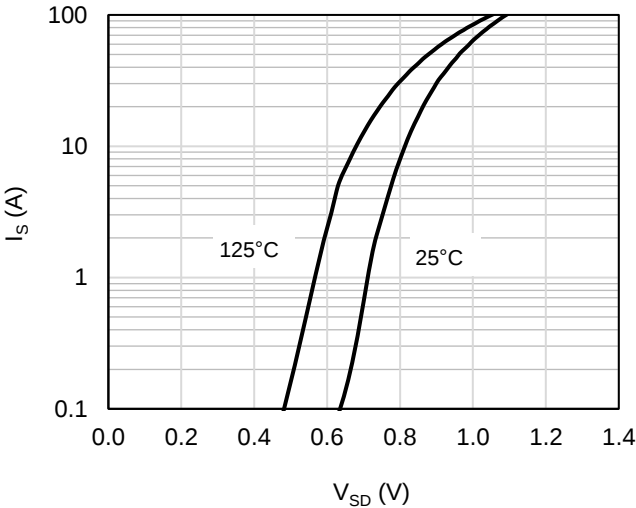


Figure 7: Body-Diode Characteristics

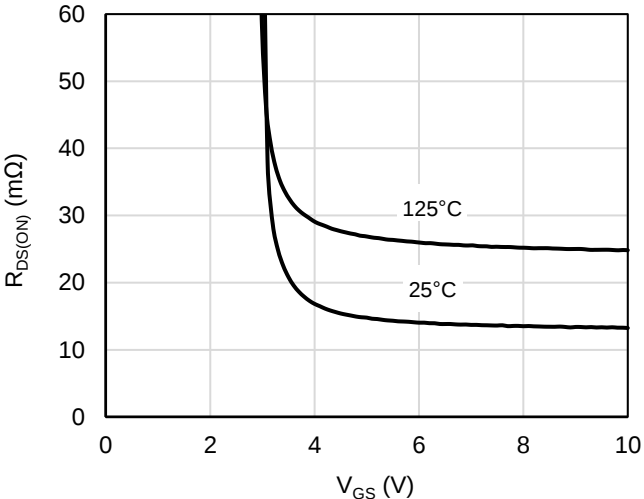


Figure 8: On-Resistance vs. Gate-Source Voltage

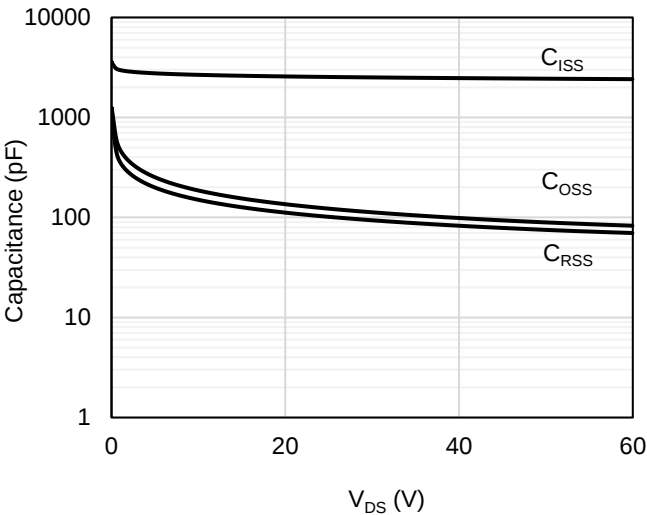


Figure 9: Capacitance Characteristics

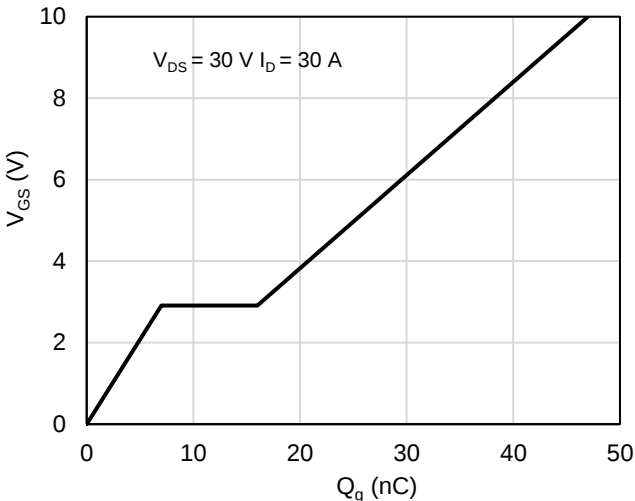


Figure 10: Gate-Charge Characteristics

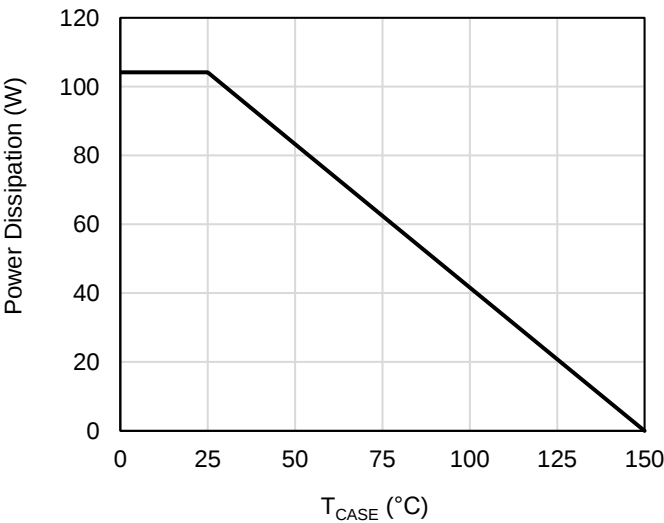


Figure 11: Power De-rating

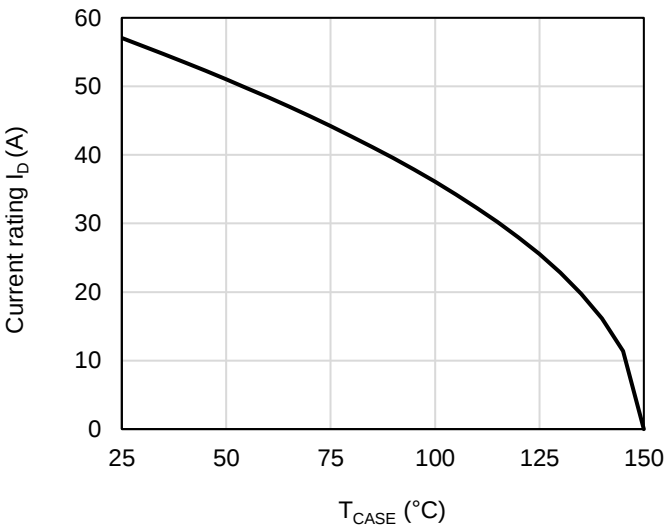
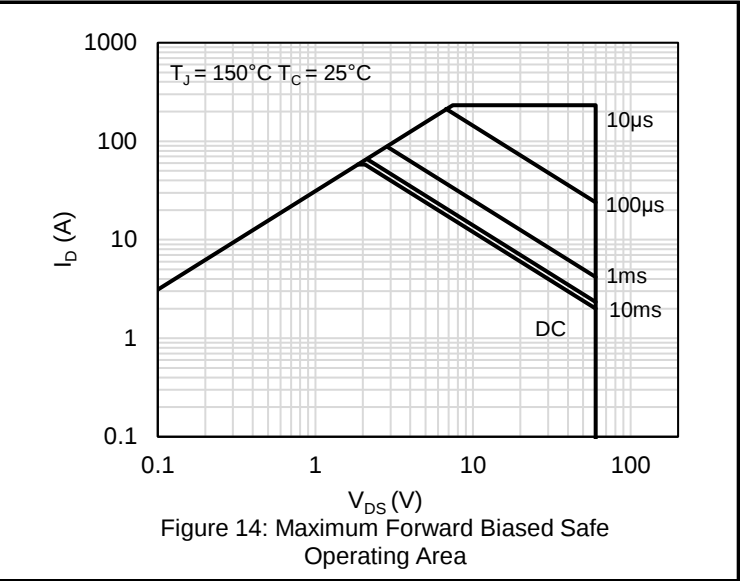
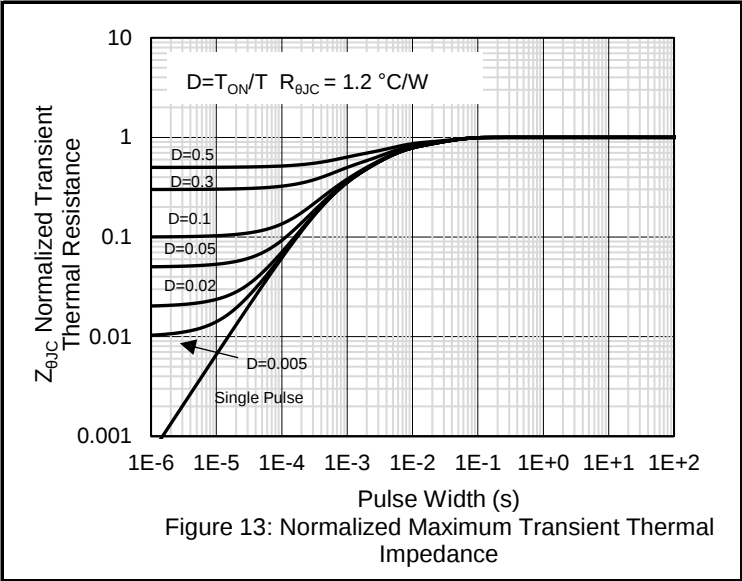
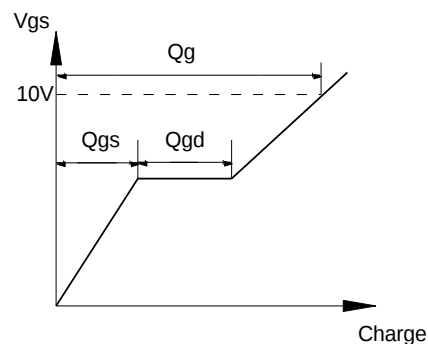
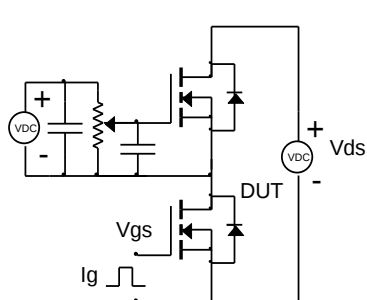


Figure 12: Current De-rating

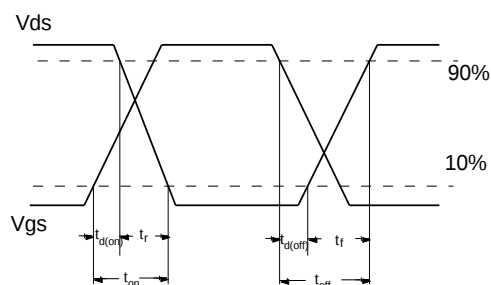
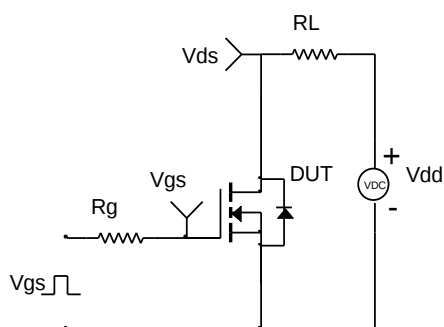


Test Circuit and Waveform

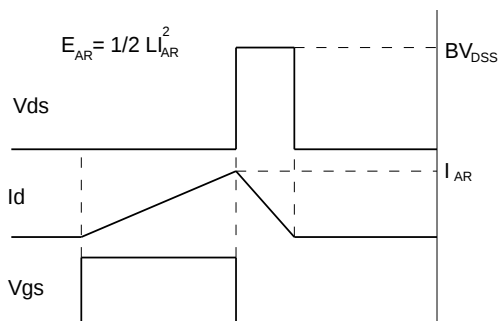
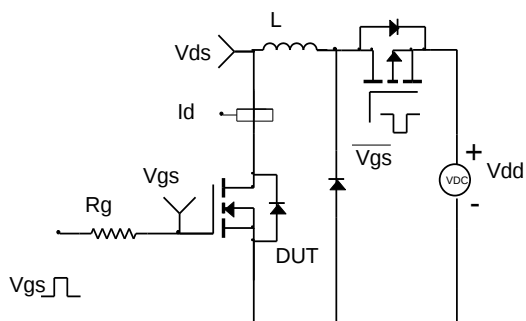
Gate Charge Test Circuit & Waveform



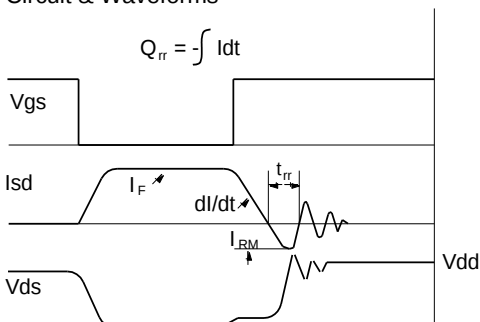
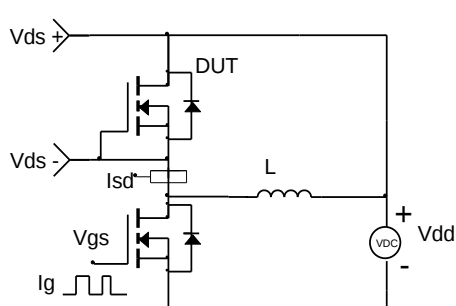
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Revision History

Revision	Release Date	Remark
Rev.1.1	2023/7/13	

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.